

Q66510 PATENT APPLICATION

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Toshio SHINTANI, et al.

Appln. No.: 09/974,048

Confirmation No.: 7616

Filed: October 11, 2001

For:

CIRCUIT BOARD AND CONNECTION STRUCTURE OF TERMINAL PORTION OF THE SAME

Group Art Unit: 2835

Examiner: Tuan T. DINH

AMENDMÉNT UNDER 37 C.F.R. § 1.111

Commissioner for Patents Washington, D.C. 20231

Sir:

In response to the Office Action dated February 28, 2002, please amend the above-

identified application as follows:

## IN THE CLAIMS:

Please enter the following amended claims:

1. (Amended) A circuit board comprising:

a terminal portion connected with an external terminal formed in an external circuit, said

Iterminal portion provided with anickel plating layer and a soldering bump;

wherein a thickness of said nickel plating layer is within a range of 1.0 to 2.5  $\mu m$ .

4. (Amended) A circuit board according to Claim 1, wherein said circuit board is a circuit provided suspension substrate.